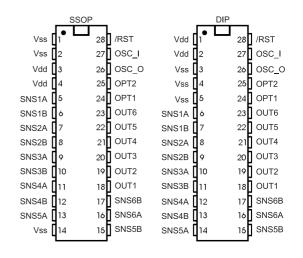


QProx™ QT160 / QT161

6 KEY CHARGE-TRANSFER QTOUCH™ SENSOR IC

- 6 completely independent touch circuits
- Individual logic outputs per channel (active high)
- Projects prox fields through any dielectric
- Only one external capacitor required per channel
- Sensitivity easily adjusted on a per-channel basis
- 100% autocal for life no adjustments required
- 3-5.5V, 5mA single supply operation
- Toggle mode for on/off control (strap option)
- 10s, 60s, infinite auto-recal timeout (strap options)
- AKS™ Adjacent Key Suppression (QT160)
- Less expensive per key than many mechanical switches
- Eval board with backlighting p/n E160



NOTE: Pinouts are not the same!

APPLICATIONS

QT160/QT161 ca e-a fe (QT')QT c IC ae ef-c a edd a c e ca abe fdeec ec 6 de e de e efed a deec c c f 6 e e c de . T e a e e c de e, ce a c, a d d. T e ca a ае e a -bea b ec е , e c b е .Teeca ab e c ead dcc ce С ca d c de add , a e Eac f e6ca e eae de e de f e e, a deac ca be ed f a са а e ca ac , a e. Tede, ce aede ed ecfca f de, ce , а e face, e c ae,a a ce, a a d c e e a ec a ca c b a bef d; e a a be ed f e aea e ,f e a - e ec ab e de e / ff СС e f .Те е c e ace e T e de, ce е е , e ca ac есае de f . T e QT160 a ffe е е е е (AKS c f e d) fea e ad ace ае ea e e d e a da e е С ,e e fa ef de ec, f еа е bе е aed, fea e e , e 3- e сае e eed be eb a а TeRISC ce feede, ce e ee ed b Q a : eeae ecfca de а се ec е ed dcae e, ca' c e 'c d adf. a e e de, ce , , e eaa d c e, e e a de, e a e, e f e f a ce c e a eca e a fe de ec еае -effec, e.

AVAILABLE OPTIONS

T _A	SSOP-28	DIP-28
0°C to +70°C	-	QT160-D
-40°C to +105°C	QT160-AS	-
0°C to +70°C	-	QT161-D
-40°C to +105°C	QT161-AS	-



1 - OVERVIEW

QT160/161 a 6-c a e b de d a c a e- a fe (QT) e de ed ecfca f c c ; e c de a a d a e a d a ce f c ece a , de abe e de a de, a e f c d . O a e c , -c ca ca ac e c a e e ed f e a .

F e 1-1 e ba c c c e de, ce. See
Tab e 7-1 a d 7-2 (a e 11) f . The DIP and
SOIC pinouts are not the same and serious damage can
occur if a part is mis-wired).

1.1
Tede cee b fcae-a fecce ac e a B de e e ea daaca ed ce RFe , e ce b

da a ca ed ce RFe , e ce b
RFfed, a d e e ece eed. I e a ,
a ed a ce ed eec e e a
æ e >f e a e e eec ec, e
c f a fdeec . Eac c a e ea ed
e e ce a c a e 1.

TeQT ceadcaeeaeeaeeadae
fcaeaeaeadafece(Fe1-2).A14-b
e- ecedcaac ADC cdebe
eedQTcaeadafeceacfa
a, dedecADCc, e.TeADC deed
dacaeeQTbeaccde
aefcaebdC, cdeede
aefcaebdC, cdeede
efeece, ae.Lae, aefCcaeecae
afeedCeeadaae
a.C, ee, ae, aefCedceeef
dffeea, aeac, ceaaabee
be eQTb.Te, aefCcabe
ceaedaaeac, ceaaabee
be eQTb.Te, aefCcabe
ceaedaaeac, ceaaabee
be eQTb.Te, aefCcabe
ceaedaaeacae

O a e e e c f e, e a fea e .

1.2

Tede ce q e 6 de e de ca e . Te e a ADC ea C eac ca e a afa a fe ca ac ; a a d ec e , e e e e e c de ca be c ec ed e e SNS1A SN1B e f a ced ffe e ce. I b ca e e e C >> C be b e, ed f e e a . Te a feca e b d ac C d ab e a e e e ca e.

I be c ec e a a e C a d C ' ad SNS1A a d SNS1B a e ,a e e dffee a f e ad e e c ec ed e e a SNS1A (SNS1B). I a ea f a ca ac a ce b e a ,e ec a f e ad C a ead a e,f e a e b ace e a d d a e ceed e C ad ec fca a d a f a a e e e ec de e f de ed.

Unused channels: If a c a e ed, a d a 1 F e e ca ac f a e be c ec ed e SNS e e c ec e a .

T e PCB ace, , a d a c e a caed c c ac SNS1A a d SNS1B bec e c e , e a d d be ea ed ca e c a ea e de ed ca . M e c e ec de ca be ed, f e a e cea e a c b b de f a bec, e, e bef e e d be ee c a ea.

1.3

1.3.1 KEY GEOMETRY AND SIZE

Tee e c e a e f e e e e c de;
ca e c e e a da e e e e a ca
e a de e c de de .T e de, ce e a e
e a e , e a d a e
e; e, e a d a e a e acce ab e.T e e e c de
ca a be a 3-d e a face b e c. Se ,
e a e d e a face e a a , c c ac
a e a, e a e a e a a d c e , a d d
c a f e e
c c .

a e. 1.3.2 Backlighting Keys

T c ad ca be
bac - a ed e ead
eec de a e
e dde(F e 1-4). T e
e ca be a a ea 4 c
da ee , ded a e f
ea a ea cea de a
e c e f e, e
a e, a d e a e eae
a 1/8 a c a e da e e
f e e. T a e d
e d e

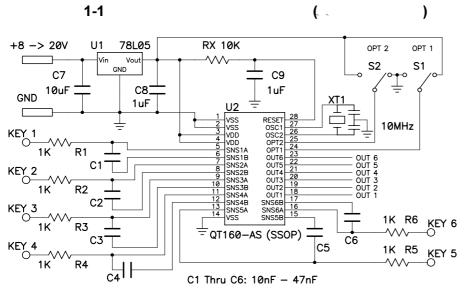
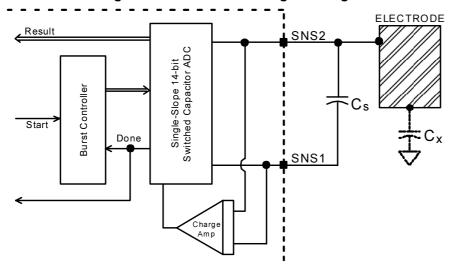


Figure 1-2 Internal Switching & Timing



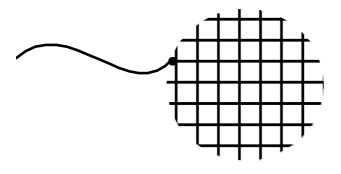
d a a e f e d a e a , e e , a d a, e e , e d d e. E e e a e e d.

S ce e c a e ac e e a e-e e ce, a f e 6 e e c de ca be aced d ec eac e f de ed c - e f e e ce.

A de a e f bac ca be f d e E160 e, a b a d f e QT160.

1.3.3 Kirchoff's Current Law

Figure 1-3 Mesh Key Geometry



e e a be e c e a fe c fa ad bac ca ea .

E ec de c ec ed e IC
e e, e ac a c a e bac
ca d, ce e e
c a e e e c a e
a e ca ed c c d.

1.3.4 VIRTUAL CAPACITIVE GROUNDS

We deec a c ac (e. a f e), d f e e e e e ed. T e a b d a a a e ea d ed c fa ad f f e e ace' ca ac a ce e ca e, e (C 3 F e f a de ea e a e ed c ea e a e ed c ea e a e e e a e e a e e a be e f ee ace' c (C 1 F e 1-5) be ee a d e e, e

c ee e e a lf ecc dca be ea ded b e, f e a e, a e c ec , e a', a ca ac, e d'a be e ed cea e e c .

A', a ca ac, e d'ca becea ed b c ec e lC> c c d :

- (1) A eab ece f ea ea ed
- (2) Afa cdc, e dae;
- (3) A a d, e a a;
- (4) A a e e e c c de ce (c be c ec ed a a).

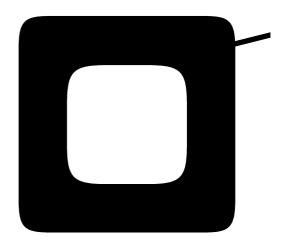


Figure 1-4 Open Electrode for Back-Illumination

Fee-fa dae caeaf dae ee ed faceaea afaaef be. Aae feaf ae eeffec fed ced aba. Va dae ae eeffec, ead cabe ade ae feae cab ded e face, feaeaa f.

1.3.5 FIELD SHAPING

Teeec decabe e, e edf e de ed dec ea acefea ed c eced

d (F e 1-6). F e a e, fa face, СС e f e d ca eadaea adceaeaa e / c aea de ed.T fed ead , ece a d e c e ec de a de a f e a a de ed.T fed eced cc d; e ca be e a e e def eec de.Te f e d ead f ad.

e de f e a e c e e e c de f ed a aff c ea , e e b ec ca ca e ad e e de ec . T ca ed 'a -b 'a d ca ed b e fac a efed adaef e e face f e e e de e a e.Aa, ed ef fa/ea ee f c eced c c d e, e a -b; a a a be ee e ded e d a d e e ec de ee e, a e f C e a d e c a ed. I e ca e f e QT160/161, e , ca be la alea f ea

1.3.6 SENSITIVITY

, a Se , ca be a e ed ca al a d aca e-b-ca e ba |Teea|e ad d ec a ac e , ae e, ae f C.M.e.C.e.dе е

1.3.6.1 Alternative Ways to Increase \$ensitivity Se , ca a be ceaedb \int b e ec de , ed c a e c e , a e a e c ae ce, ae aec

Figure 1-5 Kirchoff's Current Law

e∕ca a,ed

ed e a a e d e a a e e fed

ca/add ec dc,|e aea |e ae

a e ;f ea e add cab ea

c, é aea e e a alea fedeecc

/aacae ea ceaefalfed

f/da ee a ead ca e

/e becbe deeced.Teae

ae a ca be ade e,b a a eadfd .Pae ... a edeed c

a.A, ¢ea

.Pae ae a

ae e

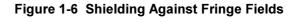
c ea e

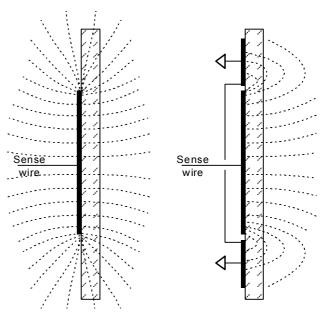
b a a

∕e ac e

c

face a ea





1.3.6.2 Decreasing Sensitivity l ecae eQT160 a be e ,e.l e a ca be e edf e b a be f a e e: a) a e e ec de a e , b) a e e ec de a a e e a ace- -c d c a (F 1-3), c) b dec ea e C ca ac

2 - QT160/QT161 SPECIFICS

2.1

T e QT160 16 b ce e a a be fa ee ed b Q a . T e a a e ecfca de ed , def , , ab eface fad e ee, e a ca e.

2.1.1 Drift Compensation Algorithm

S adfca cc beca e fc a e C,C,ad Vdd , e e. If a ade C ca ac c e , e e ea e. If e ae bec acadf ea e e e fe ea ead d, e acaa f.l c ca adfbec e aed, e e fa e de ec , -de ec , a d e , f

Dfc ea (F e2-1) ae daae efe e ce e, e ac e a a a a a e, de ec effec T e a e f efe e ce ad be e f ed e e e a e de ec de ec ca a ed.TelCdfc e ae eacca e de e de a e -ae edca e efeecee,e; e e dad ee ,aeae efe e ce.

O cea bec e ed, edfc e a ec a ceae ce e a e ae d cae e efe e ce e, e cae.

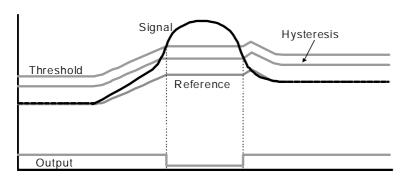
adfc e a æ e c>, e efe e ce fa e a de e e d f-c e a e e d ec e ae fa e f decea e e.S ecfca , c a af cea a .lcea bec e aedf c , cea a ac

cb´-c dc,e.

, e, e f efbe de

e c

Figure 2-1 Drift Compensation



c dbec e aedf a a e e bef e e, e
a ac e e e e e c de. H e, e, a b c
, e e e e ad, f c e e a a ead ade
f a a cef, c d dde be e , ed ea, e
e a a fca e e, a ed efe e ce e, e a d
bec e e , e c.l a e ca e, e e
c e a e f e b e c > e , a , e c , a
a fe e c d .

W a e, a e f C a d a, a e f C, d f c e a a ea ea e a e c , e e.

2.1.2 THRESHOLD CALCULATION

Te e a e de,e f ed a 6 c f a c a e . T e e IC > e a f ed e e f 2 c be e e d (33%).

2.1.3 Max On-Duration

If a bec aeac acaeeade a aee eade a aee ea .T ee ce'cd, ee cdeaeeacae deec .If adeec e ceed e e e, e e cae e e e f e).T a eMaO-D a feae.

Afe e Ma O -D a e, a, e e c a e ce a a f c a , e e f a a f b c ed, e be f ab , e e ec de c d . T e e a e ee e d a a a abe, a a :10,60,ad f e (d ab ed) (Tab e 2-1).

Ma O -D a de e de e c a e; a e ca e a effec a e ca e e ce e e AKS fea e ac ed a ad ace e . N e a a e c :D b e ec e ded fe e c a, e e e .

If e e ef a ca eea ed de ec ca cc a d e e e efec e de ec a e l f e e de, e de e da e ca e be e a d f C, C, a d Vdd d ca e e de, ed f e e e fed.

Tedea fa-da ceae fe ada fab eae a 33, .e. a a e a e f 5.5 e c a e.

2.1.4 DETECTION INTEGRATOR

I de abe e de ec e e a ed b e ec ca e f c b e a bec. T acc

, e IC> c a e a de ec e a c e a c e eac de ec a eac ed, af e c e ac, a ed. If de ec e ed ef a c , e c e e e ed a e e . I e QT160/161, e e ed c 3.

T e De ec I e a ca a be, e ed a a \times e \to f e , a e e ee de ec ee cce , e b c ea e a .

2.1.5 Forced Sensor Recalibration

P 28 a Re e , ac , e , c ca e e e e e cea ca be ed Vdd. O e - , e de, ce a a ca eca b a e a 6 c a e f e .

P 28 ca a be c ed b c a c c e f ce e c eca b a e, b f 5 e a a a .

2.1.6 RESPONSE TIME

Re e e f ed a 99 a a 10MH c c . Re e e ca be a e ed b c a e c c f e e c .

D b e ec e ded c c f e e c 20MH a, e e e e 49 .

Re e e bec e e f e a d a f a b ea e a 33 , .e. a a, e a e f 5.5 e c a e.

2.2

T e IC a e de ed f a fe b a d ca acc da e a e e e e . T e e a e e e c ab e a e Tab e 2-1.

2.2.1 DC MODE OUTPUT

2.2.2 TOGGLE MODE OUTPUT

T ae ee e d a / ff de eaf f .I ef f c e ad , f ea e c e a ace, e , c e , ec.

Ma O -D a T e de f ed a 10 ec d.
We a e cc, e e ecabae b ea e
e ae ca ed.

2.2.3 OUTPUT DRIVE

5

Te aeac, e-adca ce 1 Aad
5 Af -dc, ec e . If dc, e ad ae ed,
ca aea, edcace dbedde
ca ed ee daae. We e eae a
de(a a)Oc e dbe ed
1 A ee af deeffecf cc,
cae e eadceceae, aed
edeadbd e; ee af ca
aeaf ece e aee ca edeec
ab adecbedbe.



Cae dbeae e eICad e adaeb e edf e a e ,ad e a e a ed. T e QT160/161 de, e e a efe e ce f e e , a d e , f ca cc c a e Vdd, a a e e ad a e c ed . T ca d ce de ec 'c c ', e eb a b ec de ec ed, e ad ed ed ff, e eac ed ad infinitum. T e a d e b ec eac ed, ad infinitum. T e, e cc e ce, e O d be aded f e de ce e a ed f a e a ed e. . ba e e . De ec ' c ', e e effec, ca cc fa ad shed e a O ac, e.

f e IC ca d ec d, e LED e e . T e LED d be c ec ed a de $\hbox{ad\,ca} \quad \hbox{de} \quad \hbox{ad} \quad \hbox{V} \quad , \qquad \hbox{a} \qquad \quad \hbox{e} \quad \hbox{e} \quad$ ac, e.

2.3 AKS™ - Adjacent Key suppression

T e QT160 (QT161) fea e ad ace e e f e a ca eee ae ae, e c eadaa ef e ce e e, e e e e de a ac,ae.AKS deec adace e b c a ea, e a e, e a e a e

Ke be 1 ca ea e fe 6 a d 2. Ke be 2 ca ea e fe 1 a d 3. Ke 3 ca ea e fe 2 a d 4 a d .

W e a c de ec ed a e , b bef e e c e d OUT ac , a ed, a c ec ade f a de ec e ad ace e . If OUT ac , e e b f e ad ace e , or if a signal of greater strength is found on them, e e e ed. T ea a be ac, a e b e 3 a d 4 f e a e; f 4 a ead e 3 c ed, e 3 be e ed. Lee, fe3ad4aeb ced, b3aa eae aa4ae eedec ade, e e 4 de ec a d 3 be e ed. O ce e de ec ed e e ea ed, e e e f ee de ec.

Dfc e a a ceaef e e c a e bee e ed, e a eae a e de, e.

T fea e a , e effec, e a e f c b d e , e adace e .W e c e e a a e f 'a 'e c e adace e c, e ed b e a ef .T e e de e ece, e e a e a e a e a c a be c ed, a d e be e ed e, e f e a e a e de ec a e e ecaea

3 - CIRCUIT GUIDELINES

C a e a e ca C ca be, a a a c f ed -K ce a c ca ac . T e acce ab e C a e f 10 F 47 F de e d e e , e ed; a e , a e f C de a d e ab e e e ab e e . Acce ab e ca ac e c de e e f , PPS f , NP0 / COG ce a c. 2-1

	OPT1	OPT2	Max On-Duration
DC Out	Gnd	Vdd	10s
DC Out	Vdd	Gnd	60s
Toggle	Vdd	Vdd	10s
DC Out	Gnd	Gnd	infinite

T e OPT1 a d OPT2 d e, e be ef fa . If e a e f a ed, e de, ce ca d a e ce e a d e be e ead.

See Tab e 2-1 f . N e a e de e d , e e e c a fe e c : D b ec e ded fe e c a, e e e

3.3

Te e ca a ef 4.5 5.5, . If f cae e ea e, eQT160/161 a dc e a ef e e ca e a a ca caee,.

If e e a ed a e eec c e ca e d be a e a e a e fee f d a e, a, a d e c ca ad e e affec e IC. T e QT160/161 ac c a e Vdd, b ca be e affec ed b a d, a e e .

T e be ca e a ed a c , e a 78L05 e e a , a a 3-e a LDO de, ce f 3V 5V.

F e ea a 0.1 F ea e b a ca ac d be ed be ee Vdd a d V ; e b a ca d be aced, e c e e de, ce' e .

3.4

Teca dbea10MH ea ceac caac deac de.3- ea ca ac d eac de. 3- e a b - ca ac de ed f e e a e e e , e a d c f d. Ma fac e c de AVX, M a a, Paa c, e c.

A e a, e a e e a c c ce ca be ed e f a e a . T e OSC_I d be c ec ed e e e a c c , a d OSC_O d be ef c ec ed.

TeelCaef c, ccedde, ce a e a e a e c f e OSC_l c c . If e f e e c f OSC_l c a ed, a a c a e d ec , f ecaeada fe e e deec e e ad ea -d a

3.5

3.5
U ed a c a e d be ef e . T e d a e a a , a e -c cad C ca ac c ec ed e SNS a e e a c c c e f c e . A a , a e f 1 F (1,000 F) X7R ff ce.

U ed c a e d a, e e e ace e ec de c ec ed e .

I cale le ele ele ele de la de ec calae, el Calae le eced fadecaca calae. He, ee, e a a e ca f e e ec de , a d c , e e e ca e , a d e ec c b ea d . P a e a a a a a e e a e a a . Te e ed e, ea a be .Tede, cede a, ed de ec SNS c ab bad ec ede, cef d ced dcae, 20 A; e ef e f e e a

I e e e ca e ESD d a ca be a ded f e

D ec ac e c d c a e ec de, ce
MOV> e e e ead ad, ed; e e de, ce
a, e e e e a e a f ea a a c C c a ecaacace feec de.

Se e -R' d be e e a ea 6 RC e-c a cc d ecaead a fe a e, e e R e added e e -R a d C e ad C. If ede, ce c eced a e e a c c c, a a cabe ed a, bef d-b ce ca e da a e e O a d/e fee e be dea b e e a de ca d ca ac, a d ed e fe e.

3.7

3.7
PCBa, d,adecefecc
qeaeabea eccefade aca ad RF e fe e ce.

Tecc e a ab e RFI , ded a ce a de e be ad e ed :

- 1. U e SMT c e ead e
- 2. A a ea dae deada deccada e e e e, a a b e a beece f e ef dead be de e e e e ed ce a C . Re e, ed ea dae d be' e ded'b b d , e e a 1c e, a 0.5 ' e a adde.
- 3. G d a e d be c ec ed a c ea e V f e IC.
- 4.R eeeaceaaf e ace e a aec eced ecc .
- 5. Se e e e c de d be e a a f e c c a d d c a e d e c c e c e d e e ' c c d; e d 5. Se eec de a ea faa fe e ce adc eRF c e e e e e .
- 7. U e a 0.1 F ce a cb a ca, e c e e QT160/161
- 8. U e e e -R' e e e e , fa a ea, a ea ec c ca eae.
- 9. B a e ca dadaaa d ed ce e- ec ed e effec . СС Fe e , e e e a be e ed a e a e e c ed e.

RF e e d e ceada ed e f d , ed ,ada

4.1 ABSOLUTE MAXIMUM SPECIFICATIONS

Operating temp	as designated by suffix
Storage temp	55°C to +125°C
VDD	
Max continuous pin current, any control or drive pin	±20mA
Short circuit duration to ground, any pin	infinite
Short circuit duration to VDD, any pin	
Voltage forced onto any pin	-0.6V to (Vdd + 0.6) Volts

4.2 RECOMMENDED OPERATING CONDITIONS

VDD	+3.0 to 5.5V
Operating temperature range, 4.5V - 5.5V (QT160-AS, QT161-AS)	40 - +105C
Operating temperature range, 3.0V - 4.5V (QT160-AS, QT161-AS)	40 - +85C
Operating temperature range (QT160-D, QT161-D)	0 - +70C
Operating frequency, 4.5V - 5.5V	4 - 20MHz
Operating frequency, 3.0V - 5.5V	4 - 10MHz
Short-term supply ripple+noise	±5mV/s
Long-term supply stability	±100mV
Cs value	1nF to 200nF
Cx value	0 to 100pF

4.3 AC SPECIFICATIONS Vdd = 5.0, Ta = recommended, C = 5 F, C = 39 F, F c = 10MH

Parameter	Description	Min	Тур	Max	Units	Notes
Trc	Recalibration time			330	ms	
Трс	Charge duration		1.2		S	
Трт	Transfer duration		1.6		S	
Твѕ	Burst spacing interval		33		ms	
TBL	Burst duration, each channel		3		ms	
NBL	Burst length, each channel		1,000		counts	
TBLMR	Allowable burst duration range	0.1		5.5	ms	Before all timings degrade
Tr	Response time		99		ms	Including detection integrator

4.4 DC SPECIFICATIONS

Vdd = 5.0V, C = 39 F, C = 5 F, F c = 10MH, Ta = ec e ded a e, e e e ed

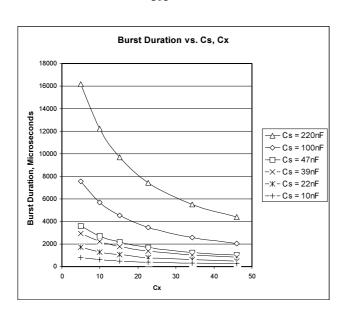
Parameter	Description	Min	Тур	Max	Units	Notes
IDD	Supply current		2.5	8	mA	
VDDS	Supply turn-on slope	100			V/s	Req'd for startup, w/o reset circuit
VIL	Low input logic level			0.7	V	OPT1, OPT2
VHL	High input logic level	2			V	OPT1, OPT2
Vol	Low output voltage			0.6	V	OUTn, 4mA sink
Voн	High output voltage	Vdd-0.7			V	OUTn, 1mA source
lıL	Input leakage current			±1	А	OPT1, OPT2
Ar	Acquisition resolution		10	14	bits	



4.5 SIGNAL PROCESSING

Description	Min	Тур	Max	Units	Notes
Threshold differential		6		counts	
Hysteresis	2		counts		
Consensus filter length (Detection integrator)		3		samples	
Positive drift compensation rate		990		ms/level	
Negative drift compensation rate	231		ms/level		
Post-detection recalibration timer duration	10, 60, infinite		secs	Option pin selected	

5.0



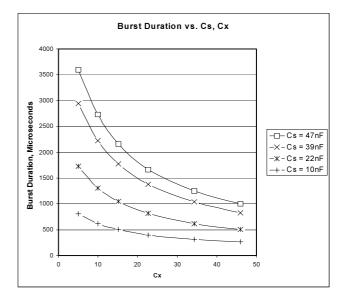


Figure 4-1

Figure 4-2

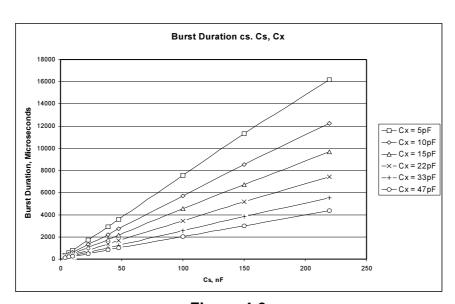


Figure 4-3

5 - PACKAGE OUTLINES

7 - PIN LISTINGS

Table 7-1 Pin Descriptions - QT160-D

Pin	Name	Function
1	Vdd	P,e e
2	Vdd	P ,e e
3	V	Nea,e e(G d)
4	V	Nea,e e(G d)
5	V	Nea,e e(G d)
6	SNS1A	Cael Ae
7	SNS1B	Cae1 B
8 9	SNS2A	Cae2 A e
	SNS2B	Cae2 B
10	SNS3A	Саез А е
11	SNS3B	Саез В
12	SNS4A	Cae4 A e
13	SNS4B	Cae4 B
14	SNS5A	Cae5 A e
15	SNS5B	Cae5 B
16	SNS6A	Cae6 A e
17	SNS6B	Cae6 B
18	OUT1	De ec 1 (ac , e)
19	OUT2	De ec 2 (ac, e)
20	OUT3	De ec 3 (ac, e)
21	OUT4	De ec 4 (ac, e)
22	OUT5	De ec 5 (ac, e)
23	OUT6	De ec 6 (ac, e)
24	OPT1	0 1
25	OPT2	O 2
26	OSC_O	Оса
27	OSC_I	Оса
28	/RST	Re e / eca b a e (ac, e)

Table 7-2 Pin Descriptions - QT160-AS

Table 7-2 Pill Descriptions - QT160-A3					
Pin	Name	Function			
1	V	Nea,e e(G d)			
2	V	Nea,e e(G d)			
3	Vdd	P ,e e			
4	Vdd	P ,e e			
5	SNS1A	Cael Ae			
6	SNS1B	Cae1 B			
7	SNS2A	Cae2 A e			
8	SNS2B	Cae2 B			
9	SNS3A	Саез А е			
10	SNS3B	Cae3 B			
11	SNS4A	Cae4 A e			
12	SNS4B	Cae4 B			
13	SNS5A	Cae5 A e			
14	V	Nea,e e(G d)			
15	SNS5B	Cae5ee B			
16	SNS6A	Cae6ee A e			
17	SNS6B	Cae6ee B			
18	OUT1	De ec 1 (ac, e)			
19	OUT2	De ec 2 (ac, e)			
20	OUT3	De ec 3 (ac, e)			
21	OUT4	De ec 4 (ac, e)			
22	OUT5	De ec 5 (ac, e)			
23	OUT6	De ec 6 (ac , e)			
24	OPT1	0 1			
25	OPT2	O 2			
26	OSC_O	Оса			
27	OSC_I	Оса			
28	/RST	Re e / eca b a e (ac, e)			

8 - ORDERING INFORMATION

PART	TEMP RANGE	PACKAGE	MARKING
QT160-D	0 - 70C	PDIP-28	QT160
QT160-AS	-40 - 105C	SSOP-28	QT160-A
QT161-D	0 - 70C	PDIP-28	QT161
QT161-AS	-40 - 105C	SSOP-28	QT161-A





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